Low-power 2-input AND gate with open-drain Rev. 01 — 15 January 2009

Product data sheet

General description 1.

The 74AUP1G09 provides the single 2-input AND gate with an open-drain output. The output of the device is an open-drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Features 2.

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-12 (0.8 V to 1.3 V)
 - JESD8-11 (0.9 V to 1.65 V)
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114E exceeds 5000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101C exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \,\mu A$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



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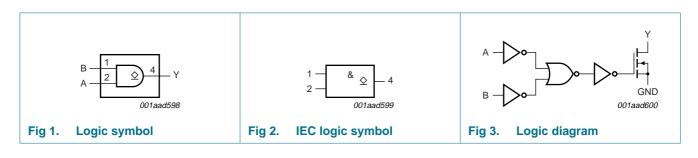
3. Ordering information

Table 1. Ordering information								
Type number Package								
	Temperature range	Name	Description	Version				
74AUP1G09GW	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1				
74AUP1G09GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886				
74AUP1G09GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm	SOT891				

4. Marking

Table 2. Marking	
Type number	Marking code
74AUP1G09GW	p9
74AUP1G09GM	р9
74AUP1G09GF	р9

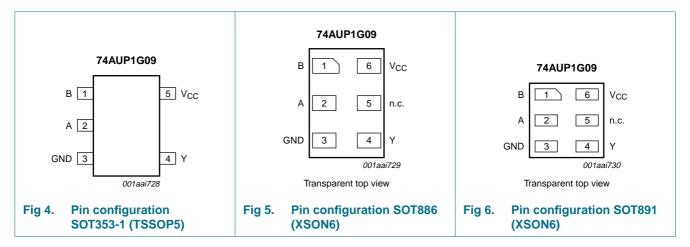
5. Functional diagram



Low-power 2-input AND gate with open-drain

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description							
Symbol	Pin		Description				
	TSSOP5	XSON6					
В	1	1	data input				
A	2	2	data input				
GND	3	3	ground (0 V)				
Y	4	4	data output				
n.c.	-	5	not connected				
V _{CC}	5	6	supply voltage				

7. Functional description

Table 4.Function table^[1]

Input		Output
Α	В	Y
L	L	L
L	Н	L
Н	L	L
н	Н	Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF state.

Low-power 2-input AND gate with open-drain

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
I _{ОК}	output clamping current	V _O < 0 V	-	-50	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	+20	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2] _	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP5 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 packages: above 45 °C the value of P_{tot} derates linearly with 2.4 mW/K.

9. Recommended operating conditions

Table 6.	Recommended operating conditi	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	Active mode and Power-down mode	0	3.6	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 0.8 V to 3.6 V	0	200	ns/V

10. Static characteristics

Table 7.Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	S °C					
V _{IH}	HIGH-level input voltage	V _{CC} = 0.8 V	$0.7V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V} \text{ to } 1.95 \text{ V}$	$0.65V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 0.8 V	-	-	$0.3V_{CC}$	V
		$V_{CC} = 0.9 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	$0.35V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V

4 of 15

Low-power 2-input AND gate with open-drain

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). Unit Symbol Parameter Conditions Min Тур Max LOW-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ VOL V I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V 0.1 _ _ $I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$ $0.3V_{CC}$ V _ _ $I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 0.31 V -- $I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ V 0.31 _ _ $I_0 = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.31 V _ _ $I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.44 V -- $I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.31 V _ _ $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.44 V μΑ I_I input leakage current $V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V ±0.1 -- $V_{I} = V_{IH}$ or V_{IL} ; $V_{O} = 0$ V to 3.6 V; OFF-state output current ±0.1 loz _ _ μΑ $V_{CC} = 3.6 V$ power-off leakage current V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V ±0.2 μΑ **I**OFF additional power-off $V_{I} \text{ or } V_{O} = 0 \text{ V to } 3.6 \text{ V;}$ ±0.2 μΑ ΔI_{OFF} -- V_{CC} = 0 V to 0.2 V leakage current $V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ supply current 0.5 Icc _ μΑ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$ ΔI_{CC} additional supply current 40 μΑ -- $V_{CC} = 0$ V to 3.6 V; $V_I = GND$ or V_{CC} 0.8 C input capacitance pF output enabled; $V_0 = GND$; $V_{CC} = 0 V$ Co output capacitance 1.7 pF -output disabled; V_O = GND; V_{CC} = 0 V -1.1 pF $T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$ V HIGH-level input voltage $V_{CC} = 0.8 V$ $0.7V_{CC}$ VIH _ _ $V_{CC} = 0.9 V$ to 1.95 V 0.65V_{CC} V -- $V_{CC} = 2.3 \text{ V}$ to 2.7 V V 16 --V $V_{CC} = 3.0 \text{ V}$ to 3.6 V 2.0 -LOW-level input voltage $V_{CC} = 0.8 V$ 0.3V_{CC} V VIL - $V_{CC} = 0.9 V$ to 1.95 V 0.35V_{CC} V -- $V_{CC} = 2.3 \text{ V}$ to 2.7 V V 0.7 -- $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ 0.9 V -LOW-level output voltage $V_I = V_{IH} \text{ or } V_{IL}$ VOL $I_{O} = 20 \ \mu A$; $V_{CC} = 0.8 \ V$ to 3.6 V 0.1 V --I_O = 1.1 mA; V_{CC} = 1.1 V 0.3V_{CC} V _ $I_0 = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$ 0.37 V -- $I_0 = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$ V _ 0.35 -I_O = 2.3 mA; V_{CC} = 2.3 V 0.33 V _ _ $I_0 = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$ 0.45 V --I_O = 2.7 mA; V_{CC} = 3.0 V V _ _ 0.33 $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.45 V _ $V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V μΑ h input leakage current ±0.5 --

Table 7. Static characteristics ...continued

Product data sheet

74AUP1G09 1

5 of 15



Low-power 2-input AND gate with open-drain

Table 7. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
l _{oz}	OFF-state output current	V_{I} = V_{IH} or $V_{IL};$ V_{O} = 0 V to 3.6 V; V_{CC} = 3.6 V	-	-	±0.5	μA
OFF	power-off leakage current	$V_{I} \text{ or } V_{O}$ = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.5	μΑ
∆l _{OFF}	additional power-off leakage current	V_{I} or $V_{O} = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.6	μA
сс	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = GND \text{ or } V_{CC}; \ I_{O} = 0 \ A; \\ V_{CC} = 0.8 \ V \text{ to } 3.6 \ V \end{array}$	-	-	0.9	μA
∆l _{CC}	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$	-	-	50	μA
T _{amb} = -	40 °C to +125 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 0.8 V$	$0.75V_{CC}$	-	-	V
		$V_{CC} = 0.9 V$ to 1.95 V	$0.7V_{CC}$	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 0.8 V$	-	-	$0.25V_{CC}$	V
		$V_{CC} = 0.9 V$ to 1.95 V	-	-	$0.3V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.11	V
		$I_0 = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	0.33V _{CC}	V
		I_{O} = 1.7 mA; V_{CC} = 1.4 V	-	-	0.41	V
		I_{O} = 1.9 mA; V_{CC} = 1.65 V	-	-	0.39	V
		I_{O} = 2.3 mA; V_{CC} = 2.3 V	-	-	0.36	V
		I_{O} = 3.1 mA; V_{CC} = 2.3 V	-	-	0.50	V
		$I_0 = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		$I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V
I	input leakage current	$V_I = GND$ to 3.6 V; $V_{CC} = 0$ V to 3.6 V	-	-	±0.75	μΑ
I _{OZ}	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = 0 V \text{ to } 3.6 V; \\ V_{CC} = 3.6 V \end{array}$	-	-	±0.75	μΑ
OFF	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	-	-	±0.75	μΑ
Δl _{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	-	-	±0.75	μA
lcc	supply current	$V_{I} = GND \text{ or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	1.4	μA
	additional supply current	$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$			75	μA



Low-power 2-input AND gate with open-drain

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit see Figure 8

Symbol	Parameter	Conditions			25 °C		-40) °C to +1	25 °C	Unit
				Min	Тур <u>[1]</u>	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 p	F									
t _{pd}	propagation delay	A or B to Y; see Figure 7	[2]							
		$V_{CC} = 0.8 V$		-	13.5	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		1.9	4.6	10.4	1.8	11.4	12.6	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		1.5	3.3	6.5	1.4	7.4	8.2	ns
		V_{CC} = 1.65 V to 1.95 V		1.2	2.9	5.1	1.1	5.9	6.5	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.2	3.8	0.9	4.5	4.9	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.9	2.3	4.0	0.8	4.5	4.9	ns
C _L = 10	pF									
pd	propagation delay	A or B to Y; see Figure 7	[2]							
		$V_{CC} = 0.8 V$		-	16.3	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		2.3	5.6	12.3	2.1	13.7	15.1	ns
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		1.8	4.1	7.6	1.7	8.8	9.7	ns
		V_{CC} = 1.65 V to 1.95 V		1.6	3.8	6.1	1.4	7.1	7.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.4	2.9	4.6	1.2	5.4	5.9	ns
		V_{CC} = 3.0 V to 3.6 V		1.3	3.2	5.7	1.1	6.4	7.0	ns
C _L = 15	pF									
pd	propagation delay	A or B to Y; see Figure 7	[2]							
		$V_{CC} = 0.8 V$		-	19.0	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		2.6	6.6	14.2	2.4	15.8	17.4	ns
		V_{CC} = 1.4 V to 1.6 V		2.1	4.8	8.7	1.9	10.1	11.1	ns
		V_{CC} = 1.65 V to 1.95 V		1.9	4.6	7.6	1.7	8.5	9.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.6	3.6	5.6	1.5	6.3	6.9	ns
		V_{CC} = 3.0 V to 3.6 V		1.6	4.1	7.5	1.4	8.3	9.1	ns
C _L = 30	pF									
pd	propagation delay	A or B to Y; see Figure 7	[2]							
		$V_{CC} = 0.8 V$		-	27.0	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.6	9.5	19.5	3.2	21.8	24.0	ns
		V_{CC} = 1.4 V to 1.6 V		2.9	7.0	11.5	2.6	13.6	15.0	ns
		V_{CC} = 1.65 V to 1.95 V		2.6	7.0	12.1	2.3	13.3	14.6	ns
		V_{CC} = 2.3 V to 2.7 V		2.4	5.4	8.9	2.1	9.9	10.9	ns
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V		2.3	6.5	12.7	2.1	13.9	15.3	ns

Low-power 2-input AND gate with open-drain

Symbol	Parameter	Conditions		25 °C			-40	0 °C to +1	25 °C	Unit
				Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
C _L = 5 p	F, 10 pF, 15 pF and	30 pF								
C _{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz};$ V _I = GND to V _{CC}	[3]							
		$V_{CC} = 0.8 V$		-	0.6	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V		-	0.7	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V		-	0.8	-	-	-	-	pF
		V_{CC} = 1.65 V to 1.95 V		-	0.9	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	1.1	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	1.4	-	-	-	-	pF

Dynamic characteristics ... continued Table 8.

[1] All typical values are measured at nominal V_{CC}.

[2] t_{pd} is the same as t_{PZL} and t_{PLZ} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

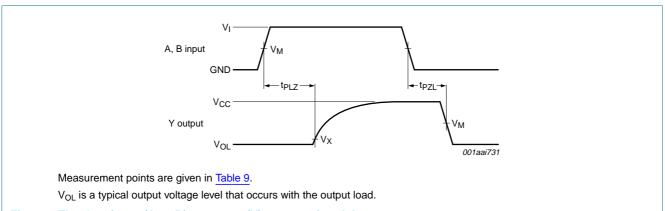
 P_{D} = $C_{PD} \times V_{CC}{}^{2} \times f_{i} \times N$ where:

 f_i = input frequency in MHz;

 V_{CC} = supply voltage in V;

N = number of inputs switching.

12. Waveforms



The data input (A or B) to output (Y) propagation delays Fig 7.

Table 9. **Measurement points**

Supply voltage	Input	Output	Output		
V _{CC}	V _M	V _M	Vx		
0.8 V to 1.6 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.1 V		
1.65 V to 2.7 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.15 V		
3.0 V to 3.6 V	0.5V _{CC}	0.5V _{CC}	V_{OL} + 0.3 V		

74AUP1G09_1 **Product data sheet**



Low-power 2-input AND gate with open-drain

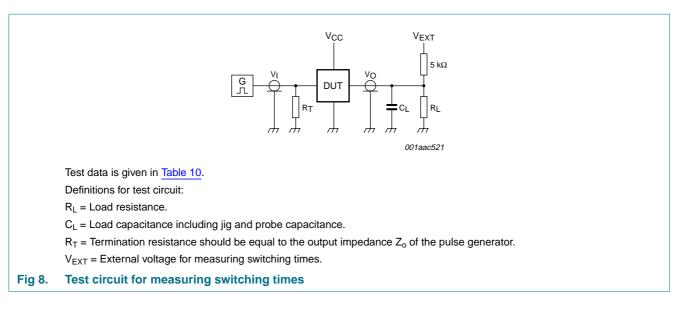


Table 10.Test data

Supply voltage	Load	V _{EXT}			
V _{CC}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	2V _{CC}

[1] For measuring enable and disable times $R_L = 5 \text{ k}\Omega$.

For measuring propagation delays, set-up and hold times, and pulse width, R_L = 1 M Ω .



Low-power 2-input AND gate with open-drain

13. Package outline

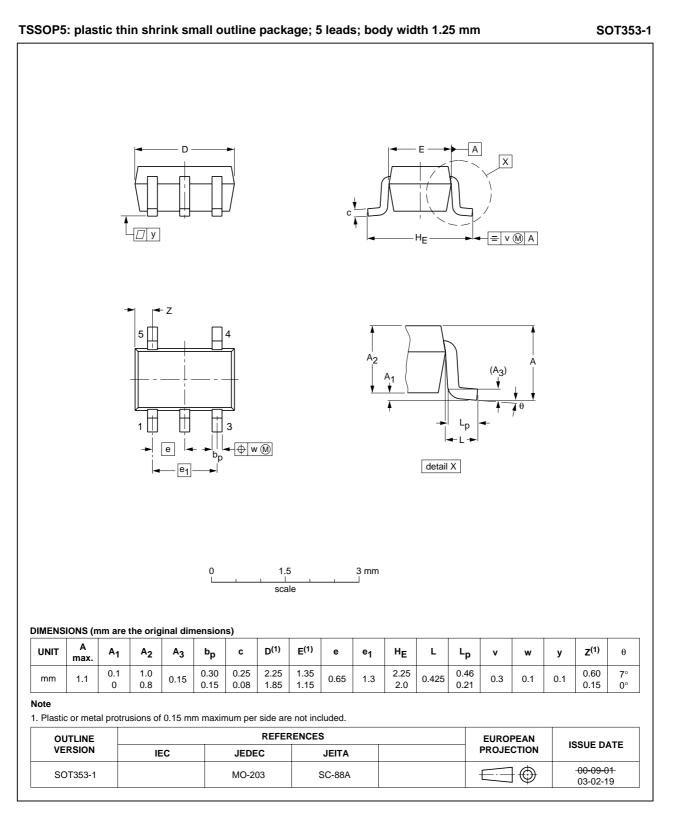


Fig 9. Package outline SOT353-1 (TSSOP5)

Low-power 2-input AND gate with open-drain

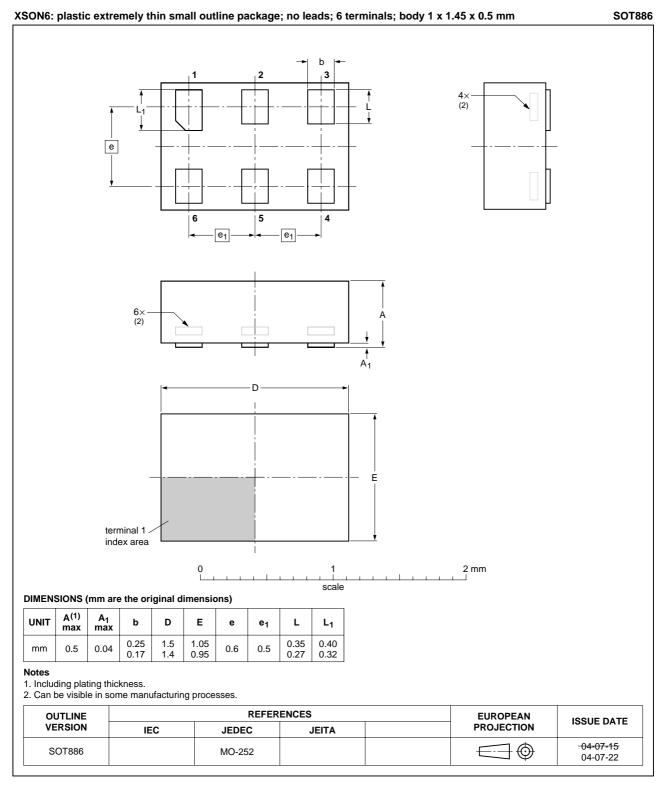


Fig 10. Package outline SOT886 (XSON6)

74AUP1G09_1 Product data sheet

Low-power 2-input AND gate with open-drain

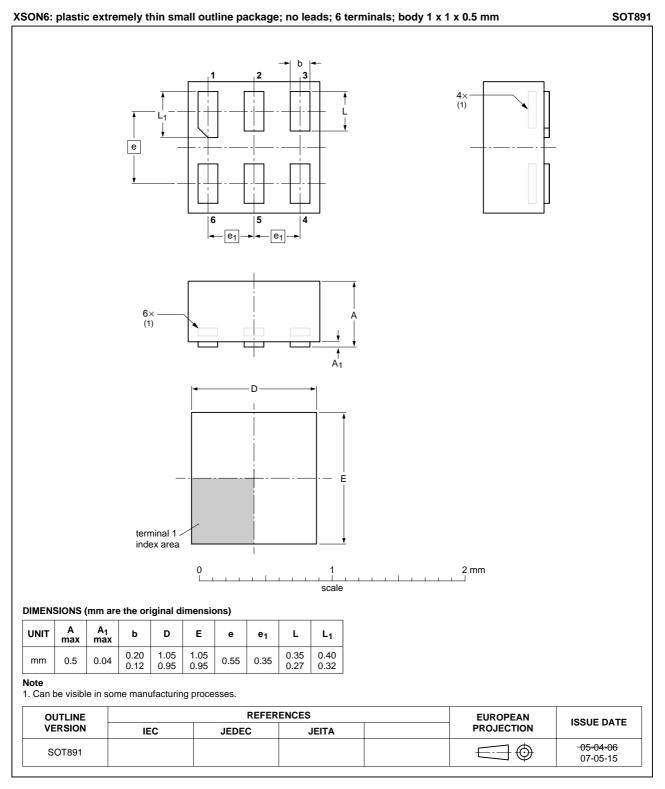


Fig 11. Package outline SOT891 (XSON6)

74AUP1G09_1 Product data sheet

Low-power 2-input AND gate with open-drain

14. Abbreviations

Table 11.	Abbreviations		
Acronym	Description		
CDM	Charged Device Model		
CMOS	Complementary Metal Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

15. Revision history

Table 12. Revision history							
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74AUP1G09_1	20090115	Product data sheet	-	-			

Low-power 2-input AND gate with open-drain

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Low-power 2-input AND gate with open-drain

18. Contents

1	General description 1
2	Features 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 2
6	Pinning information 3
6.1 6.2	Pinning 3 Pin description 3
7	Functional description 3
8	Limiting values 4
9	Recommended operating conditions 4
10	Static characteristics 4
11	Dynamic characteristics 7
12	Waveforms 8
13	Package outline 10
14	Abbreviations 13
15	Revision history 13
16	Legal information 14
16.1	Data sheet status 14
16.2	Definitions 14
16.3	Disclaimers 14
16.4	Trademarks 14
17	Contact information 14
18	Contents 15

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